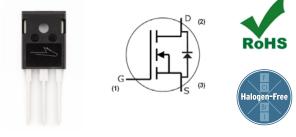


C3M0280090D

Silicon Carbide Power MOSFET C3M[™] MOSFET Technology N-Channel Enhancement Mode

Features

- C3M Silicon Carbide (SiC) MOSFET technology
- High blocking voltage with low On-resistance
- High speed switching with low capacitances
- Fast intrinsic diode with low reverse recovery (Q_{rr})
- Halogen free, RoHS compliant



Part Number	Package	Marking
C3M0280090D	TO 247-3	C3M0280090

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Typical Applications

- Renewable energy
- Lighting
- High voltage DC/DC converters
- Telecom Power Supplies
- Induction Heating

Benefits

- Higher system efficiency
- Reduced cooling requirements
- Increased power density
- Increased system switching frequency

Key Parameters

Parameter	Symbol	Min.	Тур.	Мах	Unit	Conditions	Note
Drain - Source Voltage	V _{DS}			900	v	T _c = 25°C	
Maximum Gate - Source Voltage	$V_{GS(max)}$	-8		+19		Transient	
Operational Gate-Source Voltage	V _{GS op}		-4/15			Static	Note 1
DC Continuous Drain Current				10.2		$V_{_{GS}} = 15 \text{ V}, \text{ T}_{_{C}} = 25 \text{ °C}, \text{ T}_{_{J}} \le 150 \text{ °C}$	Fig. 19 Note 2
DC Continuous Drain Current	I D			6.8	А	$V_{_{GS}} = 15 \text{ V}, \text{ T}_{_{C}} = 100 \text{ °C}, \text{ T}_{_{J}} \le 150 \text{ °C}$	
Pulsed Drain Current	I _{DM}			22		t_{Pmax} limited by T_{jmax} $V_{GS} = 15V, T_{C} = 25 \text{ °C}$	Fig. 22
Power Dissipation	P _D			45	w	$T_{c} = 25^{\circ}C, T_{J} = 150^{\circ}C$	Fig. 20
Operating Junction and Storage Temperature	T _J , T _{stg}			-55 to +150	°C		
Solder Temperature	TL			260		According to JEDEC J-STD-020	
Mounting Torque	M _D			1 8.8	Nm Ibf-in	M3 or 6-32 screw	

Note (1): Recommended turn-on gate voltage is 15V with ±5% regulation tolerance, see Application Note PRD-04814 for additional details Note (2): Verified by design

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Electrical Characteristics ($T_c = 25^{\circ}C$ unless otherwise specified)

Parameter	Symbol	Min.	Тур.	Max.	Unit	Test Conditions	Note
Drain-Source Breakdown Voltage	V _{(BR)DSS}	900	_	—		V _{GS} = 0 V, I _D = 100 μA	İ
Gate Threshold Voltage, TJ = 25℃	N	1.8	2.7	3.5	V		_
Gate Threshold Voltage, TJ = 150℃	V _{GS(th)}	_	2.2	_		$V_{DS} = V_{GS}, I_D = 1.2 \text{ mA}$	Fig. 11
Zero Gate Voltage Drain Current	I _{DSS}	-	1	100	μA	$V_{DS} = 900 \text{ V}, V_{GS} = 0 \text{ V}$	
Gate-Source Leakage Current	I _{GSS}	-	10	250	nA	$V_{GS} = 15 V, V_{DS} = 0 V$	
Drain-Source On-State Resistance, TJ = 25°C		-	320	360	-		Fig. 4, 5, 6
Drain-Source On-State Resistance, T _J = 150°C	R _{DS(on)}	-	416	-	mΩ	$V_{GS} = 15 \text{ V}, \text{ I}_{D} = 7.5 \text{ A}$	
Transconductance, T _J = 25°C			3.6		S		
Transconductance, T _J = 150°C	g _{fs}	_	3.6	_	5	$V_{DS} = 20 \text{ V}, I_{DS} = 7.5 \text{ A}$	Fig. 7
Input Capacitance	C _{iss}	-	204	-			
Output Capacitance	C _{oss}	-	26	-	pF	$V_{GS} = 0 V, V_{DS} = 600 V$ f = 1 Mhz	Fig. 17, 18
Reverse Transfer Capacitance	C _{rss}	-	3	-		f = 1 MHZ V _{AC} = 25 mV	17,10
Output Capacitance Stored Energy	E _{oss}	-	5.5	-			Fig. 16
Turn-On Switching Energy (Body Diode FWD)	Eon	-	80	-	μJ	$V_{DS} = 400 \text{ V}, V_{GS} = -4 \text{ V}/15 \text{ V}, I_{D} = 7.5 \text{ A},$	Fig. 26,
Turn Off Switching Energy (Body Diode)	E _{off}	-	6	-		$R_{G(ext)} = 2.5 \Omega$, L= 201 µH, T _J = 150°C	29
Turn-On Delay Time	t _{d(on)}	-	5.3	-		$V_{DD} = 400 \text{ V}, \text{ V}_{GS} = -4 \text{ V}/15 \text{ V}$	Fig. 27, 29 Note 3
Rise Time	tr	-	25	-		$I_D = 7.5 \text{ A}, R_{G(ext)} = 2.5 \Omega,$	
Turn-Off Delay Time	$t_{d(off)}$	-	8.5	-	ns	Timing relative to V _{DS}	
Fall Time	t _f	_	6.4	_		Inductive load	
Internal Gate Resistance	R _{G(int)}	-	23.5	-	Ω	$f = 1 \text{ MHz}, V_{AC} = 25 \text{ mV}$	
Gate to Source Charge	Q _{gs}	_	3	_		$V_{DS} = 400 \text{ V}, \text{ V}_{GS} = -4 \text{ V}/15 \text{ V}$	
Gate to Drain Charge	Q _{gd}	_	2.9	_	nC	I _D = 7.5 A	Fig. 12
Total Gate Charge	Qg	_	9.7	_	Per IEC60747-8-4 pg 21		

Reverse Diode Characteristics ($T_c = 25^{\circ}C$ unless otherwise specified)

Parameter	Symbol	Тур.	Max.	Unit	Test Conditions	Note	
Diode Forward Voltage	N	4.8	_	V	$V_{GS} = -4 V, I_{SD} = 4 A$	Fig. 8, 9, 10	
	V _{SD}	4.4	_		$V_{GS} = -4 V$, $I_{SD} = 4 A$, $T_{J} = 150^{\circ}C$		
Continuous Diode Forward Current	I _S	-	9		V _{GS} = -4 V		
Diode Pulse Current	I _{SM}	-	22	A	V_{GS} = -4 V, Pulse width limited by $T_{J_{max}}$		
Reverse Recover Time	t _{rr}	24	_	nS			
Reverse Recovery Charge	Q _{rr}	74	_	nC	$V_{GS} = -4 V$, $I_{SD} = 7.5 A$, $V_{R} = 400 V$ dif/dt = 775 A/µs, $T_{I} = 150^{\circ}C$		
Peak Reverse Recovery Current	Irrm	4	_	А			

Thermal Characteristics

Parameter	Symbol	Max	Unit	Note
Thermal Resistance from Junction to Case	R _{θJC}	2.8	°C/W	Fig. 21
Thermal Resistance From Junction to Ambient	R _{0JA}	40	°C/W	Fig. 21

Note:

³ Turn-off and Turn-on switching energy and timing values measured using SiC MOSFET Body Diode



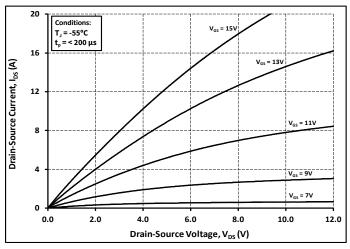
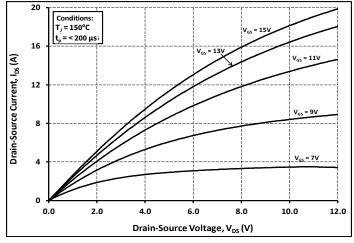
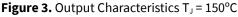
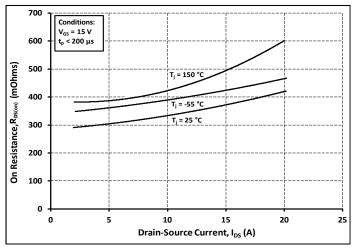
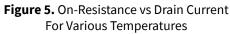


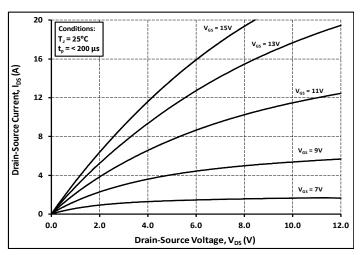
Figure 1. Output Characteristics T_J = -55°C













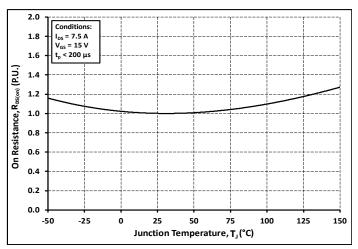
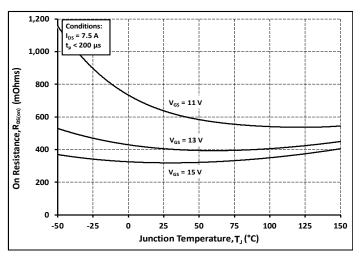
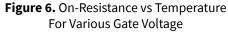


Figure 4. Normalized On-Resistance vs Temperature

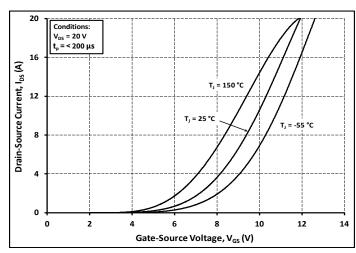


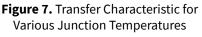


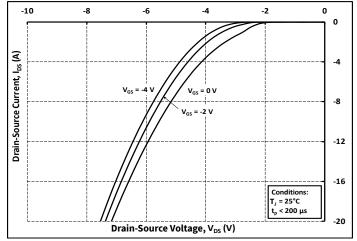
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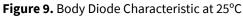
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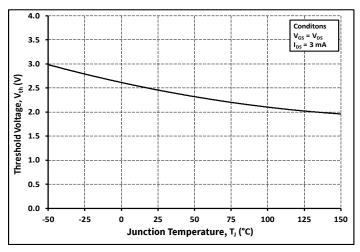


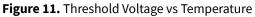












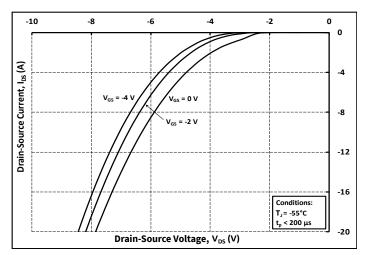


Figure 8. Body Diode Characteristic at -55°C

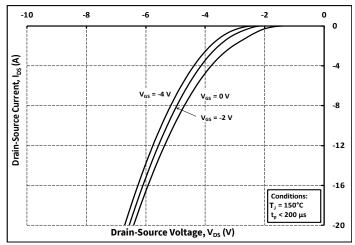
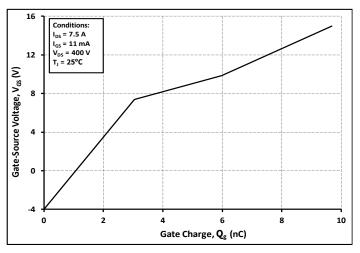


Figure 10. Body Diode Characteristic at 150°C





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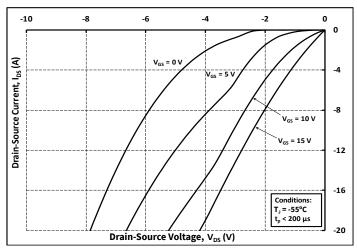


Figure 13. 3rd Quadrant Characteristic at -55°C

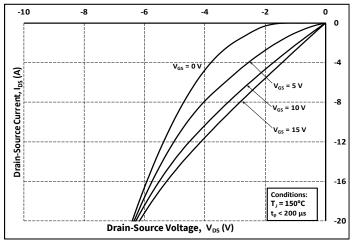
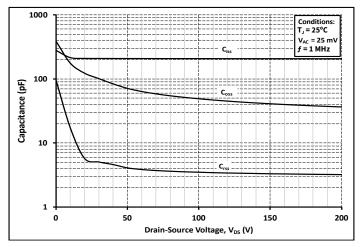
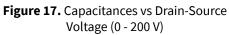


Figure 15. 3rd Quadrant Characteristic at 150°C





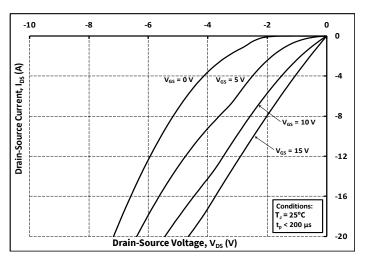


Figure 14. 3rd Quadrant Characteristic at 25°C

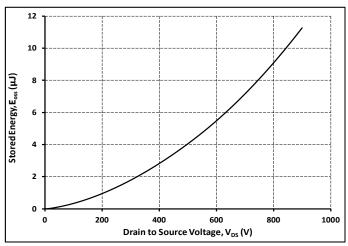


Figure 16. Output Capacitor Stored Energy

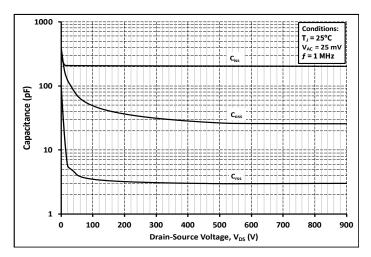
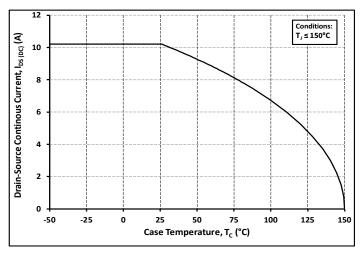


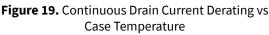
Figure 18. Capacitances vs Drain-Source Voltage (0 - 900 V)

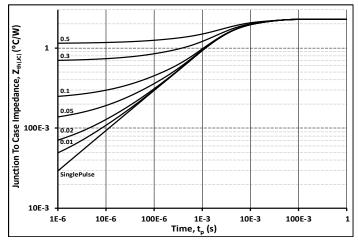
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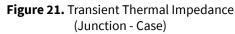
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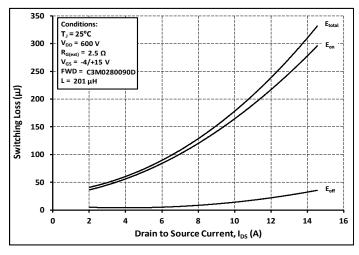


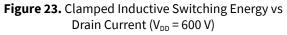












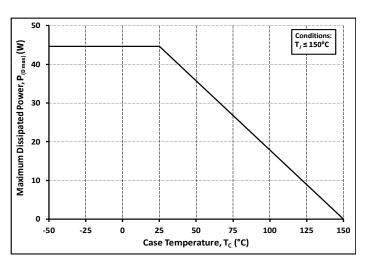


Figure 20. Maximum Power Dissipation Derating vs Case Temperature

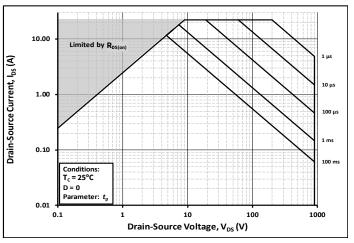


Figure 22. Safe Operating Area

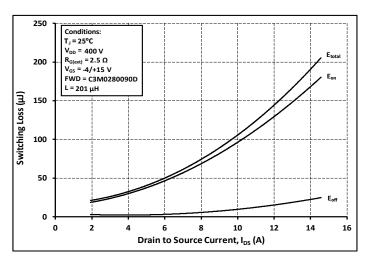


Figure 24. Clamped Inductive Switching Energy vs Drain Current (V_{DD} = 400 V)

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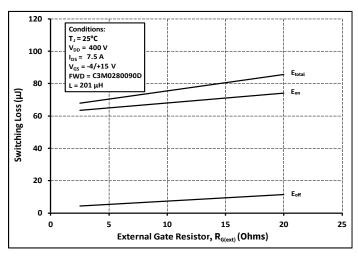


Figure 25. Clamped Inductive Switching Energy vs $R_{G(ext)}$

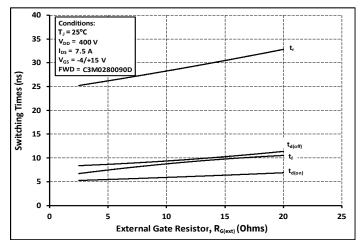


Figure 27. Switching Times vs. $R_{G(ext)}$

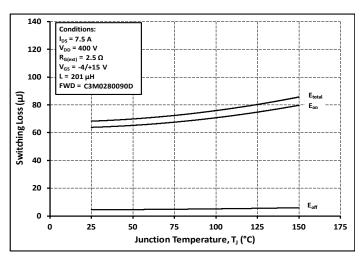


Figure 26. Clamped Inductive Switching Energy vs Temperature

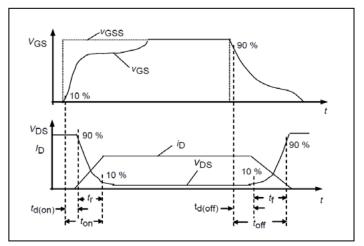


Figure 28. Switching Times Definition

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Test Circuit Schematic

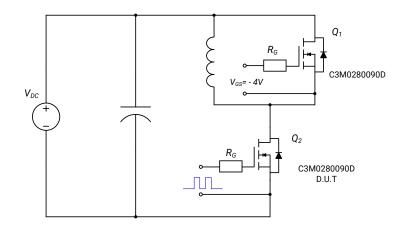


Figure 29. Clamped Inductive Switching Test Circuit

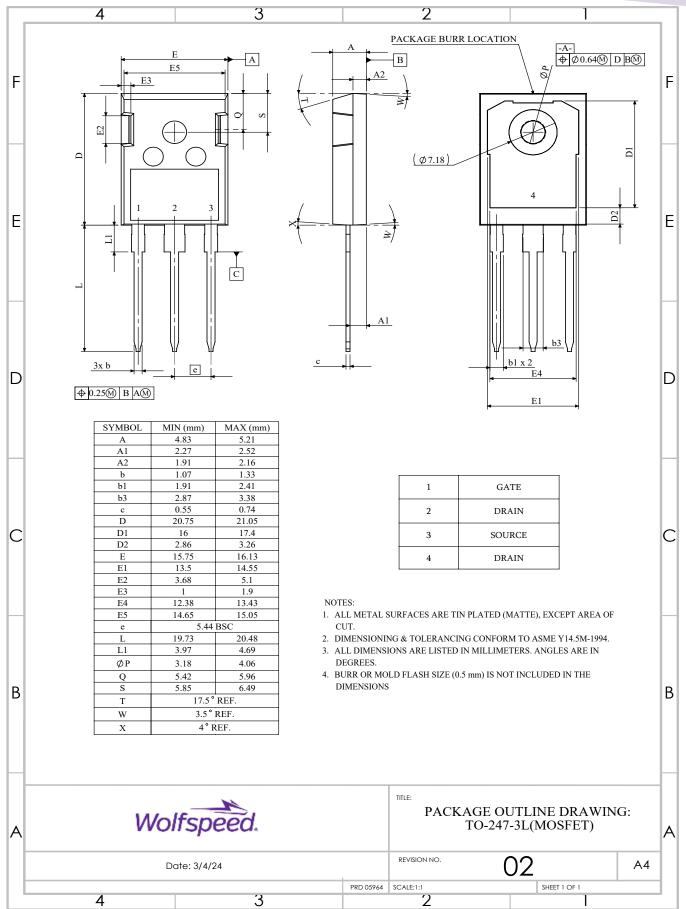
Note:

Turn-off and Turn-on switching energy and timing values measured using SiC MOSFET Body Diode as shown above.

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Package Dimensions – Package TO-247-3

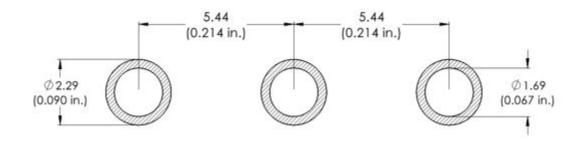


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Recommended Solder Pad Layout



Revision History

Current Revision	Date of Release	Description of Changes
2	September-2021	N/A
3	November-2023	Not Released
4	January-2024	Updated Wolfspeed branding, package drawing, package image, and solder pad layout, added Revision History Table, Table 1 layout revised
5	September - 2024	Legal Disclaimer, POD, Diode Pulse Current Symbol

Related Links

- SPICE Models
- SiC MOSFET Isolated Gate Driver reference design
- SiC MOSFET Evaluation Board

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